

April 1995

8A, 400V - 600V Hyperfast Dual Diodes
Features

- Hyperfast with Soft Recovery.....<30ns
- Operating Temperature+175°C
- Reverse Voltage Up To600V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Description

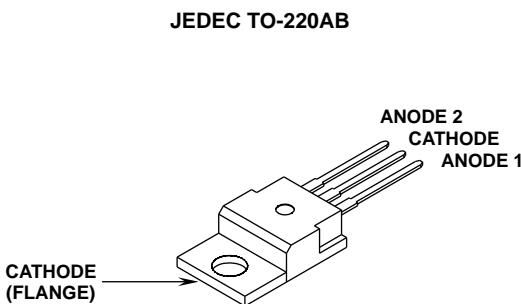
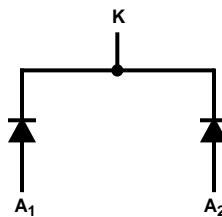
RHRP840CC, RHRP850CC and RHRP860CC (TA49059) are hyperfast dual diodes with soft recovery characteristics ($t_{RR} < 30\text{ns}$). They have half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
RHRP840CC	TO-220AB	RHRP840C
RHRP850CC	TO-220AB	RHRP850C
RHRP860CC	TO-220AB	RHRP860C

NOTE: When ordering, use the entire part number.

Package

Symbol

Absolute Maximum Ratings (per leg) $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

	RHRP840CC	RHRP850CC	RHRP860CC	UNITS
Peak Repetitive Reverse Voltage.....	V_{RRM}	400	500	V
Working Peak Reverse Voltage	V_{RWM}	400	500	V
DC Blocking Voltage.....	V_R	400	500	V
Average Rectified Forward Current	$I_{F(AV)}$	8	8	A
($T_C = 150^\circ\text{C}$)				
Repetitive Peak Surge Current.....	I_{FSM}	16	16	A
(Square Wave, 20kHz)				
Nonrepetitive Peak Surge Current.....	I_{FSM}	100	100	A
(Halfwave, 1 Phase, 60Hz)				
Maximum Power Dissipation	P_D	75	75	W
Avalanche Energy (See Figures 10 and 11).....	E_{AVL}	20	20	mJ
Operating and Storage Temperature	T_{STG}, T_J	-65 to +175	-65 to +175	$^\circ\text{C}$

Specifications RHRP840CC, RHRP850CC, RHRP860CC

Electrical Specifications (per leg) $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	LIMITS									UNITS	
		RHRP840CC			RHRP850CC			RHRP860CC				
		MIN	Typ	MAX	MIN	Typ	MAX	MIN	Typ	MAX		
V_F	$I_F = 8\text{A}, T_C = +25^\circ\text{C}$	-	-	2.1	-	-	2.1	-	-	2.1	V	
	$I_F = 8\text{A}, T_C = +150^\circ\text{C}$	-	-	1.7	-	-	1.7	-	-	1.7	V	
I_R	$V_R = 400\text{V}, T_C = +25^\circ\text{C}$	-	-	100	-	-	-	-	-	-	μA	
	$V_R = 500\text{V}, T_C = +25^\circ\text{C}$	-	-	-	-	-	100	-	-	-	μA	
	$V_R = 600\text{V}, T_C = +25^\circ\text{C}$	-	-	-	-	-	-	-	-	100	μA	
I_R	$V_R = 400\text{V}, T_C = +150^\circ\text{C}$	-	-	500	-	-	-	-	-	-	μA	
	$V_R = 500\text{V}, T_C = +150^\circ\text{C}$	-	-	-	-	-	500	-	-	-	μA	
	$V_R = 600\text{V}, T_C = +150^\circ\text{C}$	-	-	-	-	-	-	-	-	500	μA	
t_{RR}	$I_F = 1\text{A}, \frac{dI_F}{dt} = 200\text{A}/\mu\text{s}$	-	-	30	-	-	30	-	-	30	ns	
	$I_F = 8\text{A}, \frac{dI_F}{dt} = 200\text{A}/\mu\text{s}$	-	-	35	-	-	35	-	-	35	ns	
t_A	$I_F = 8\text{A}, \frac{dI_F}{dt} = 200\text{A}/\mu\text{s}$	-	18	-	-	18	-	-	18	-	ns	
t_B	$I_F = 8\text{A}, \frac{dI_F}{dt} = 200\text{A}/\mu\text{s}$	-	10	-	-	10	-	-	10	-	ns	
Q_{RR}	$I_F = 8\text{A}, \frac{dI_F}{dt} = 200\text{A}/\mu\text{s}$	-	56	-	-	56	-	-	56	-	nC	
C_J	$V_R = 10\text{V}, I_F = 0\text{A}$	-	25	-	-	25	-	-	25	-	pF	
$R_{\theta JC}$		-	-	2	-	-	2	-	-	2	$^\circ\text{C}/\text{W}$	

DEFINITIONS

V_F = Instantaneous forward voltage ($pw = 300\mu\text{s}$, $D = 2\%$).

I_R = Instantaneous reverse current.

t_{RR} = Reverse recovery time (See Figure 2), summation of t_A + t_B .

t_A = Time to reach peak reverse current (See Figure 2).

t_B = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 2).

Q_{RR} = Reverse recovery charge.

C_J = Junction Capacitance.

$R_{\theta JC}$ = Thermal resistance junction to case.

E_{AVL} = Controlled avalanche energy. (See Figures 10 and 11).

pw = pulse width.

D = duty cycle.

V_1 AMPLITUDE CONTROLS I_F
 V_2 AMPLITUDE CONTROLS dI_F/dt

L_1 = SELF INDUCTANCE OF
 $R_4 + L_{\text{LOOP}}$

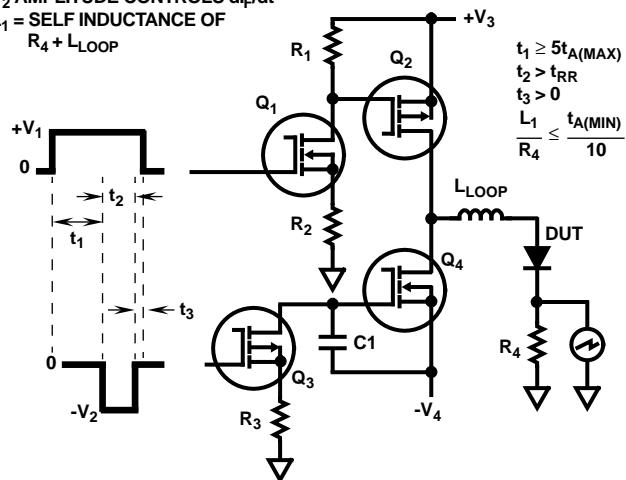


FIGURE 1. t_{RR} TEST CIRCUIT

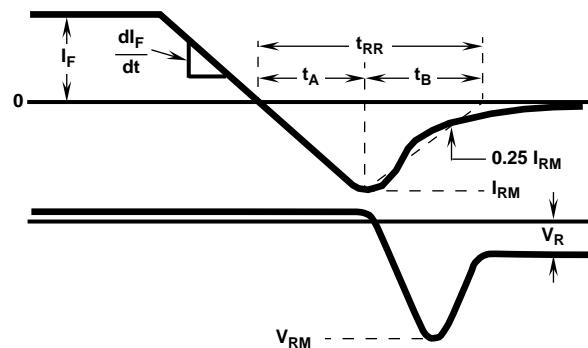


FIGURE 2. t_{RR} WAVEFORMS AND DEFINITIONS

RHRP840CC, RHRP850CC, RHRP860CC

Typical Performance Curves

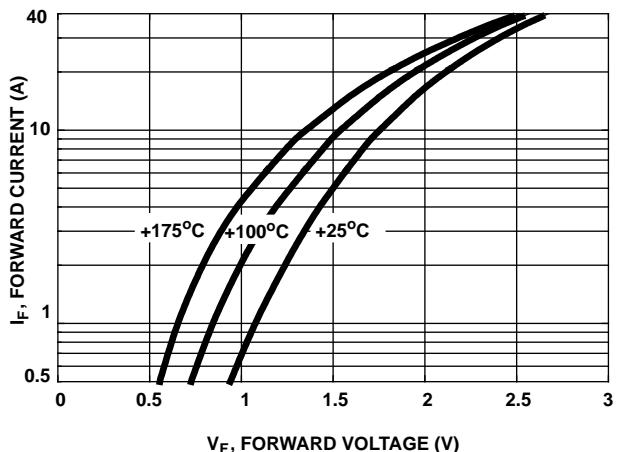


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

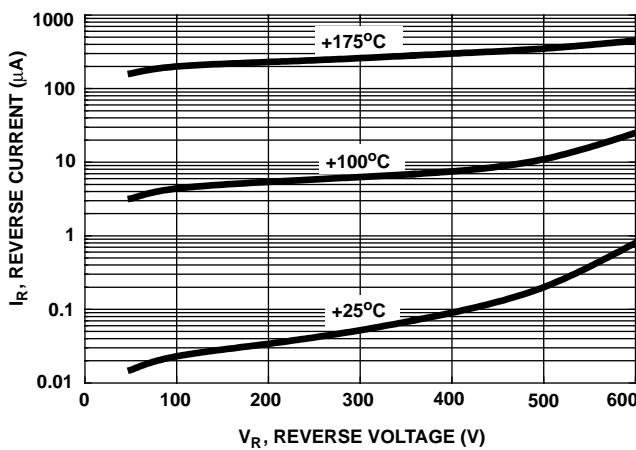


FIGURE 4. TYPICAL REVERSE CURRENT vs REVERSE VOLTAGE

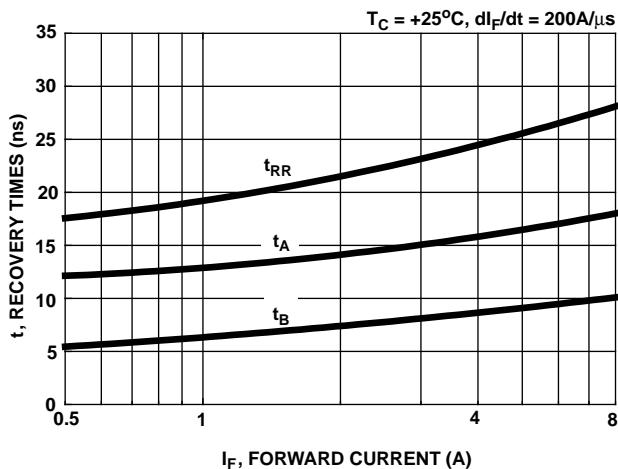


FIGURE 5. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +25°C

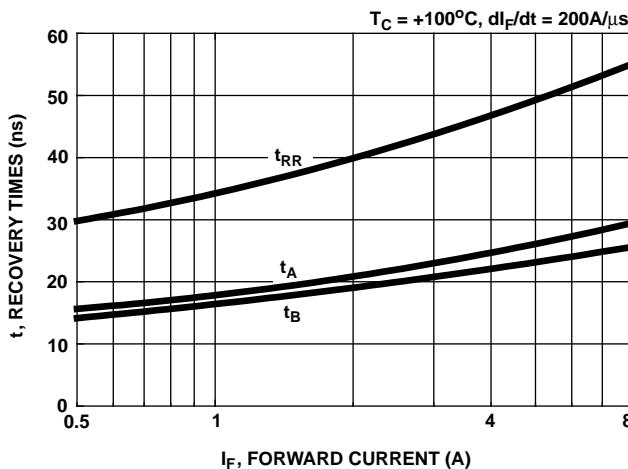


FIGURE 6. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +100°C

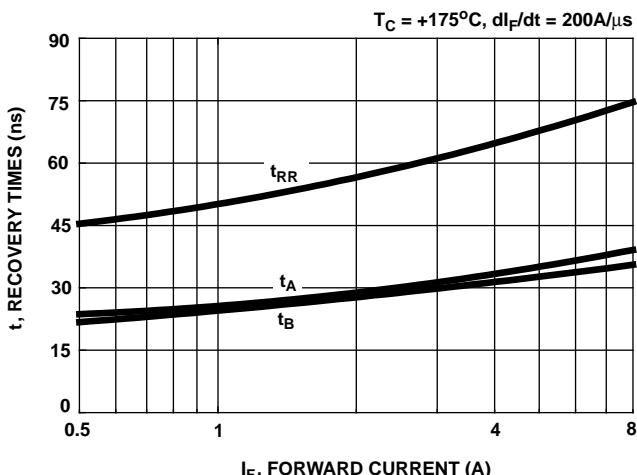


FIGURE 7. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +175°C

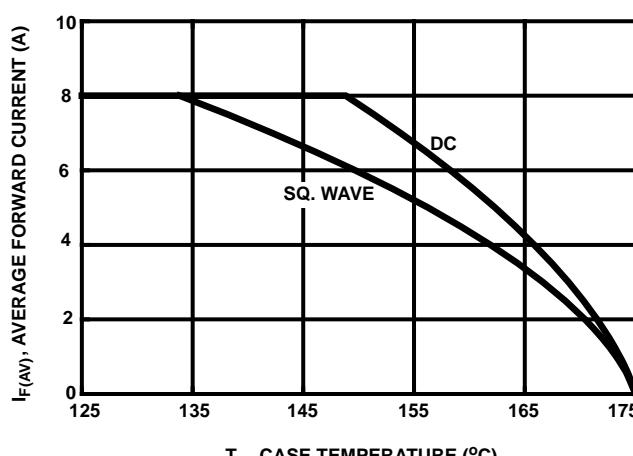


FIGURE 8. CURRENT DERATING CURVE FOR ALL TYPES

Typical Performance Curves (Continued)

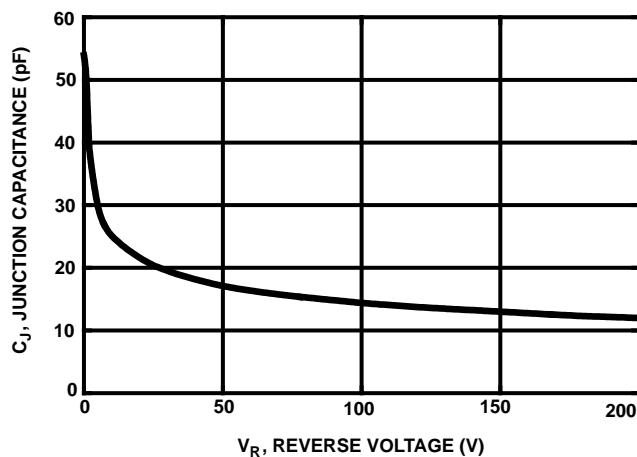


FIGURE 9. TYPICAL JUNCTION CAPACITANCE vs REVERSE VOLTAGE

I_{MAX} = 1A

MAX
L = 40mH

$R < 0.1W$

$$E_{AVL} = 1/2LI^2 [V_{AVL}/(V_{AVL} - V_{DD})]$$

Q₁ AND Q₂ ARE 1000V MOSFETs

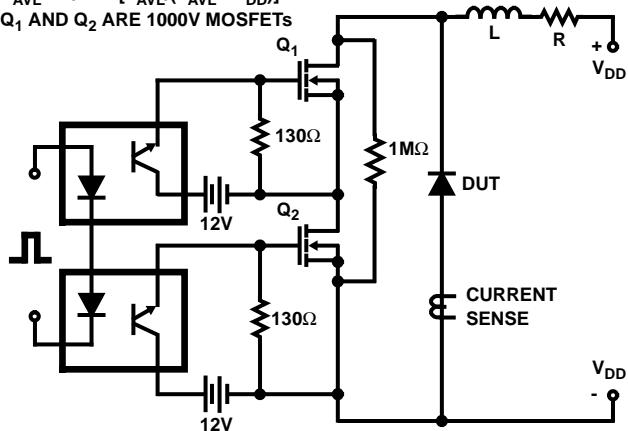


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

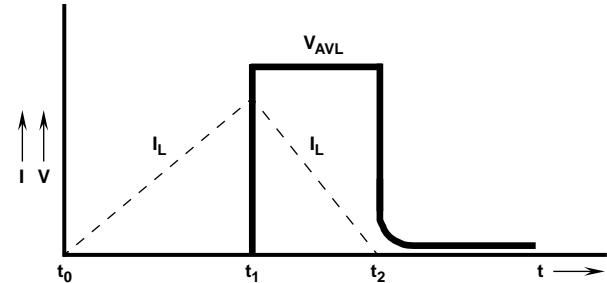


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS